

**Roland Lausecker**

## **Natural shellac as a sustainable MEMS material**

**A low-tech material for high-tech processing**



**IMTEK, Universität Freiburg**

# **Natural shellac as a sustainable MEMS material**

**A low-tech material for high-tech processing**

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**Roland Lausecker**

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Freiburg, November 29, 2017

Roland Lausecker



*I dedicate this work to my wife Kinga, my parents Gabriele and Berthold and my sister Franziska. Thank you for your love, inspiration and support.*



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